

L Number	Hits	Search Text	DB	Time stamp
1	1194	(chip or die) same etch\$5 same carrier	USPAT; EPO; JPO; IBM_TDB	2002/12/10 09:42
2	205	(chip or die) same etch\$5 same shield\$5	USPAT; EPO; JPO; IBM_TDB	2002/12/10 09:43
4	136	((chip or die) same etch\$5 same carrier) and shield\$5	USPAT; EPO; JPO; IBM_TDB	2002/12/10 09:37
7	1410	(chip or die) and etch\$5 and carrier and (light or beam or ray) and shield\$5	USPAT; EPO; JPO; IBM_TDB	2002/12/10 10:03
9	1109	((chip or die) and etch\$5 and carrier and (light or beam or ray) and shield\$5) and semiconductor	USPAT; EPO; JPO; IBM_TDB	2002/12/10 09:48
13	754	("flip chip" or die) same etch\$5 same (light or beam or ray)	USPAT; EPO; JPO; IBM_TDB	2002/12/10 11:06
14	1951	((438/14) or (438/401) or (438/108) or (438/127)).CCLS.	USPAT; EPO; JPO; IBM_TDB	2002/12/10 11:07
15	21	((chip or die) and etch\$5 and carrier and (light or beam or ray) and shield\$5) and (((438/14) or (438/401) or (438/108) or (438/127)).CCLS.)	USPAT; EPO; JPO; IBM_TDB	2002/12/10 11:08